

Voltage or Current References

Circuit that yields a precise DC voltage or current independent of external influences is called a voltage reference or a current reference.

The primary external influences are:

- Power supply variations
- Temperature variations

Sensitivity and Fractional Temp. Coefficient

Used to characterize the dependence of a reference on power supply and temperature.

A. The Sensitivity of \dot{V}_{ref} to changes in power supply V_{DD} is given by

$$\mathbf{S}_{\mathbf{v}_{00}}^{\mathbf{V}_{\text{ref}}} = \frac{\mathbf{V}_{\text{DD}}}{\mathbf{V}_{\text{ref}}} \cdot \frac{\partial \mathbf{V}_{\text{ref}}}{\partial \mathbf{V}_{\mathbf{B}}} \qquad (1)$$

Or,
$$\frac{\partial V_{ref}}{V_{ref}} = S_{V_{DD}}^{V_{ref}} \cdot \frac{\partial V_{DD}}{V_{DD}}$$
 (2)

Sensitivity

Sensitivity may vary from 0.0 to 1.0.

Sensitivities less than 0.01 are practical values for a monolithic voltage reference.

The above formulation is valid for current references by simply replacing V_{ref} by I_{ref}.

Fractional Temp. Coefficient

B. The Sensitivity of V_{ref} to changes in temperature T is given by, S_T^{Vief}.

$$S_{T}^{V_{ref}} = \frac{T}{V_{ref}} \cdot \frac{\partial V_{ref}}{\partial T}$$

Got just by replacing V_{DD} by T in each (1)

Or,
$$\frac{\partial V_{ref}}{V_{ref}} = \mathbf{S}_{T}^{V_{ref}} \cdot \frac{\partial T}{T}$$

Fractional Temp. Coefficient

Fractional Temp. Coefficient, TC_F(V_{ref}):

This is another popular concept used to measure the degree of temperature dependence of reference.

$$TC_F(V_{ref}) = 1N_{ref} (\partial V_{ref}/\partial T) = 1/T (S_T^{Vref})$$

Units of TC_F - parts per million/°C or ppm/°C.

Example:

Sensitivity, $S_T^{Vref} = 0.01$ at room temperature, $\Rightarrow TC_F(V_{ref}) = 1/T (S_T^{Vref})$ $= (1/300) \times 0.01 \times 1,000,000$ $= 33.3 \text{ ppm/}^{\circ}C$

References with TC_F of less than 50ppm/°C are considered to be stable w.r.t. temperature.

Simple Voltage References

In CMOS IC design, we can derive reference voltages from the power supplies using resistors and MOSFETs.

- 1. Resistor Only Voltage Reference
- 2. Resistor MOSFET Voltage Reference
- 3. MOSFET Only Voltage Reference

1. Resistor – Only Voltage Reference

This voltage divider, formed with 2 resistors, provide a DC voltage between V_{DD} and ground depending on values of R_1 and R_2 .

Here,
$$V_{ref} = \frac{R_2}{(R_1 + R_2)} V_{DD}$$

Advantages:

- Simple
 - Temperature Insensitive
- Process Insensitive—changes in the sheet resistance have no effect on the voltage division.

Disadvantages:

- To reduce the power dissipation, the resistors must be made large. But large resistors require a large die area.
- The sensitivity of V_{ref} w.r.t. V_{DD} is found to be,

$$\mathbf{S}_{V_{DD}}^{V_{ref}} = \frac{V_{DD}}{V_{ref}} \cdot \frac{\partial V_{ref}}{\partial V_{DD}} = 1$$

2. Resistor - MOSFET Voltage Reference

Since gate and drain terminals are shorted, M₁ always remains in saturation.

Here,
$$V_{DS} = V_{GS} = V_{ref}$$

$$I_D = (V_{DD} - V_{ref})/R = \frac{1}{2}\beta_1(V_{GS} - V_{tn})^2$$

Or,
$$V_{ref} = V_{tn} + \sqrt{\frac{2I_D}{\beta_1}} = V_{tn} + \sqrt{\frac{2(V_{DD} - V_{ref})}{R\beta_1}}$$

$$\boldsymbol{S}_{V_{DD}}^{V_{ref}} = \frac{V_{DD}}{V_{ref}} \cdot \frac{\partial V_{ref}}{\partial V_{DD}} = \frac{1}{V_{tin} \cdot \sqrt{\frac{2 R \beta_1}{V_{DD}} + 2}}$$

$$TC_F(V_{ref}) = \frac{1}{N} \cdot \frac{\partial V_{ref}}{\partial P}$$

$$TC_{F}(V_{rel}) = \frac{1}{V_{rel}} \left[\frac{\partial V_{in}}{\partial T} - \frac{1}{2} \sqrt{\frac{2V_{DD}}{R\beta_{1}}} \left(\frac{1}{R} \frac{\partial R}{\partial T} - \frac{1.5}{T} \right) \right]$$

3. MOSFET - Only Voltage Reference

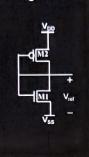
This generates a reference voltage equal to the voltage on the gates of the MOSFETs w.r.t. ground.

$$\frac{1}{2}\beta_{1}(V_{ref}V_{SS}-V_{th})^{2} = \frac{1}{2}\beta_{2}(V_{DD}-V_{ref}V_{tb})^{2}$$

Or the reference voltage is given by,

$$V_{rel} = \frac{V_{DD} - V_{tp} + \sqrt{\frac{\beta_1}{\beta_2}} (V_{SS} + V_{tn})}{\sqrt{\frac{\beta_1}{\beta_2}} + 1}$$

$$\frac{\beta_1}{\beta_2} = \left[\frac{(V_{DD}\text{-}V_{ref}\text{-}V_{tp})}{(V_{ref}\text{-}V_{SS}\text{-}V_{tn})} \right]^2$$



Sensitivity of V_{ref} w.r.t. V_{DD} is given by,

$$\boldsymbol{S}_{V_{DD}}^{V_{tef}} = \frac{V_{DD}}{V_{ref}} \cdot \frac{\partial V_{ref}}{\partial V_{DD}} = \frac{V_{DD}}{V_{DD} - V_{tp} + \int_{\beta_2}^{\beta_1} (V_{SS} + V_{tn})}$$

Assuming the temperature dependence of the ratio of the transconductance parameters, β_1/β_2 , is negligible, the $TC_F(V_{ref})$ is given by,

$$TC_F(V_{ref}) = \frac{1}{V_{ref}} \cdot \frac{\partial V_{ref}}{\partial T}$$

$$TC_F(V_{ref}) = \ \frac{1}{V_{ref}} \ \frac{1}{\sqrt{\frac{\beta_1}{\beta_2}} \ + 1} \left[\frac{\partial (-V_{tp})}{\partial T} \ + \sqrt{\frac{\beta_1}{\beta_2}} \ \frac{\partial V_{tn}}{\partial T} \right]$$

To achieve $TC_F(V_{ref}) = 0$ requires,

 $TC_{F}(V_{ref}) = \frac{1}{V_{ref}} \frac{1}{\sqrt{\frac{\beta_{1}}{R}} + 1} \left[\frac{\partial (-V_{tp})}{\partial T} + \sqrt{\frac{\beta_{1}}{\beta_{2}}} \frac{\partial V_{tn}}{\partial T} \right] = 0$

i.e., $\frac{\partial (-V_{tp})}{\partial T} = -\sqrt{\frac{\beta_1}{\beta_2}} \frac{\partial V_{tn}}{\partial T} \Rightarrow 2.7 \text{mV} / ^{\circ}\text{C} = \sqrt{\frac{\beta_1}{\beta_2}} (2.4 \text{mV} / ^{\circ}\text{C})$

i.e., $\beta_1/\beta_2 = 1.125$

Zero temperature coefficient, to a first order can be met by satisfying this equation. However, this ratio is most often set by the desired V_{ref} . So for a particular single value of V_{ref} , the reference becomes temperature insensitive.

Design Example:

Design a 3V MOSFET-Only voltage reference. Determine the temperature coeff. of the reference. Data given: V_{DD} =+5V, V_{SS} =0V, V_{ID} =0.8V, V_{ID} =0.9V, V_{L1} = V_{L2} =5 V_{L1} = V_{L2} =5 V_{L1} = V_{L2} =5 V_{L2} = V_{L2} =V

$$\frac{\beta_1}{\beta_2} = \left[\frac{(5-3.0.9)}{(3-0.0.8)} \right]^2 = 0.25$$

Setting $L_1=L_2=W_1=5\mu m$,

$$\frac{\beta_1}{\beta_2} \; = \; \frac{K_n W_1 L_2}{K_p W_2 L_1} \; = \; \frac{50 \mu A N^2 \, 5 \mu m \, 5 \mu m}{17 \mu A N^2 \, W_2 \, 5 \mu m} \; = 0.25$$

Solving gives, W2 = 60 µm.

The temp. coeff. is given by,

$$TC_{F}(V_{ref}) = \frac{1}{V_{ref}} \frac{1}{\int \frac{\beta_{1}}{\beta_{1}} + 1} \left[\frac{\partial (-V_{tp})}{\partial T} + \sqrt{\frac{\beta_{1}}{\beta_{1}}} \frac{\partial V_{tn}}{\partial T} \right]$$

But,
$$\frac{\partial V_{tn}}{\partial T} = V_{tn} .TCV_{tn} = (0.8V)(-0.003/^{\circ}C) = -2.4mV/^{\circ}C$$

$$-\frac{\partial V_{tp}}{\partial T} = -V_{tp} \cdot TCV_{tp} = -(0.9V)(-0.003/^{\circ}C) = 2.7mV/^{\circ}C$$

$$TC_F(V_{rel}) = \frac{1}{3} - \frac{1}{\sqrt{\frac{50x5}{17x60} + 1}} \left[0.0027 + \sqrt{\frac{50x5}{17x60}} (-0.0024) \right]$$

= 337ppm /°C

Current Source Self-Biasing Circuits

The drawback of the 3 references discussed so far are that, they are very sensitive to power supply and temperature.

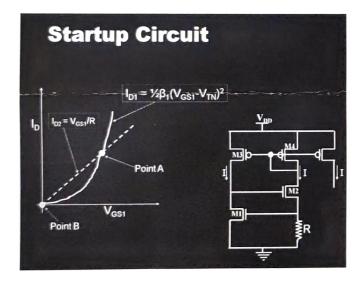
Here, we discuss 3 methods of biasing which reduce the effects of power supply variations and possibly temp

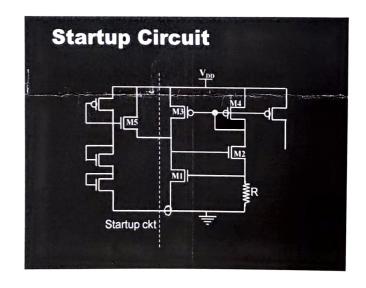
- 1. Threshold Voltage Referenced Self-Biasing
- 2. Diode Referenced Self-Biasing
- 3. Thermal Voltage Referenced Self-Biasing

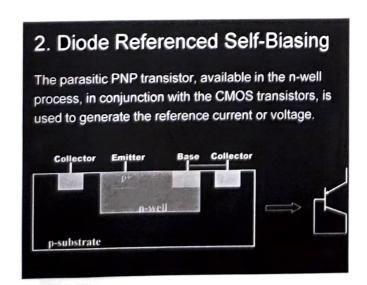
1. Threshold Voltage Referenced Self-Biasing MOSFETs M3 & M4 force the same current to flow through M1 & M2. $IR = V_{GS1} = V_{TN} + \sqrt{\frac{2I}{\beta_1}}$ If β_1 is very large, then, I is given by, $I \approx V_{TN}/R$ i.e., current is independent of the power supply voltage (neglecting channel length modulation and body effect). $I = \frac{1}{2} \frac{1}{1} \frac{1}{1$

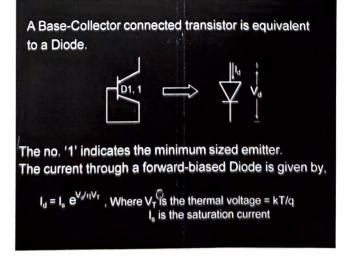
Note:

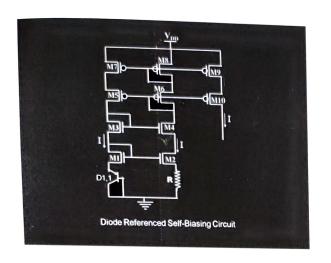
- Here we assumed the output resistance of the MOSFET were infinite. But by cascoding M3 and M4 helps to make the bias circuit behave more ideal.
- The accuracy of I is limited by the threshold voltage accuracy, which may vary by 20%, and the n+ resistivity, which may vary by 20% as well.
- TC_F(I) depends on TC_F(V_{TN}) and TC_F(R).
 But TC_F(V_{TN}) = -3000 ppm/°C and TC_F(R) = +2000ppm/°C.
 So, the reference current, I has a large negative temperature coefficient.











Here the cascode mirrors made with M1 through M8 force the same current, I, to flow through D1 and R

$$I = V_d/R = I_s.e^{V_d/\eta V_T}$$

Or, $V_d = \eta V_T \ln (I/I_s)$

Solving for the resistor gives,

$$R = \frac{\eta V_T}{I} \ln(I/I_s)$$

The main benefit of this circuit over the threshold referenced self-biasing circuit is the better matching, from wafer to wafer and on the same die, of the diode voltage over the threshold voltage.

Sensitivity and TC_F(I_{ref}):

This shows that the reference is insensitive to power supply variations.

$$TC_{F}(I_{ref}) = \frac{1}{I_{ref}} \frac{\partial I_{ref}}{\partial T} = \frac{1}{I_{ref}} \frac{\partial}{\partial T} \left(\frac{V_{d}}{R} \right)$$

$$\frac{1}{1} \int_{\text{ref}} \frac{\left[R \frac{\partial V_d}{\partial I} + V_d \frac{\partial R}{\partial I} \right]}{R^2}$$

$$TC_F(I_{ref}) = \frac{1}{V_d} \frac{\partial V_d}{\partial T} - \frac{1}{R} \frac{\partial R}{\partial T} = TC_F(V_d) - TC_F(R)$$

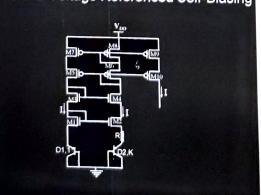
 $TC_F(I_{ref}) = TC_F(V_d) - TC_F(R)$

Drawback: Temperature dependence.

The temp. coeff. of the diode ≈ - 3,300ppm/°C and R has +2000ppm/°C. This causes the biasing circuit to have a large negative temperature coefficient.

Therefore, this reference is also called as **CTAT** (Complimentary To Absolute Temperature).

3. Thermal Voltage Referenced Self-Biasing



M1 through M8 forces the same current through D1 and D2.

$$I_{d1} = I_{e}. e^{V_{d1}/\eta V_{T}} \longrightarrow V_{d1} = \eta V_{T} \ln \frac{1}{I_{e}}$$

$$I_{d2} = K I_0 \cdot e^{V_{d2}/\eta V_T} \longrightarrow V_{d2} = \eta V_T \ln \frac{1}{KL}$$

From eqn. (1), solving for the resistor, R, gives,

$$R = (V_{d1} - V_{d2})/I = \frac{\eta V_T}{I} \ln (K)$$

Or,
$$|I = \frac{\eta V_T}{R} \ln (K) | = \frac{\eta k}{qR} \ln (K) . T | V_T = kT/q$$

Or,
$$I = \frac{\eta V_T}{R} \ln (K) = \frac{\eta k}{qR} \ln (K).T$$

Here, the current is proportional to the absolute temperature (PTAT)

$$TC_{F}(I_{ref}) \ = \ \frac{1}{I_{ref}} \, \frac{\partial I_{ref}}{\partial T} \ = \ \frac{1}{I_{ref}} \, \frac{\partial}{\partial T} \bigg(\frac{\eta V_{T}}{R} \, In \, (K) \bigg)$$

$$TC_F(I_{rel}) \ = \ \frac{1}{V_T} \, \frac{\partial V_T}{\partial T} \, - \ \ \frac{1}{R} \, \frac{\partial R}{\partial T} \ \ = \ \ \underline{TC_F(V_T)} \, - \, \underline{TC_F(R)}$$

$$TC_F(I_{ref}) = TC_F(V_T) - TC_F(R)$$

Advantages:

Since both V_T and R exhibit positive temperature coeff., it gives better temperature characteristics than the diode or threshold voltage references.

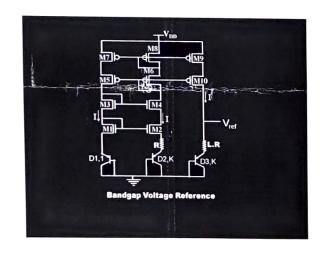
 $TC_F(V_T) \approx +3,300 \text{ ppm/}^{\circ}\text{C}$, and $TC_F(R) = +2000 \text{ ppm/}^{\circ}\text{C}$ Hence, $TC_F(I_{rel}) \approx 1,300 \text{ ppm/}^{\circ}\text{C}$

Drawbacks:

Mismatches in the gate-source voltages of M1 and M2 can result in large variations in I_{ref}.

Bandgap Voltage References

Bandgap voltage references combine the <u>positive TC</u> of the thermal voltage with the <u>negative TC</u> of the diode forward voltage in a circuit to achieve a voltage reference with a <u>zero TC</u>.



Diode D3 is the same size as D2, while the resistor in series with D3 is L times larger than the resistor in series with D2.

The current I in the figure is given by,

$$I = \frac{\eta V_T}{\Omega} \ln (K)$$

The reference output voltage w.r.t. ground is given by,

$$V_{ref} = I.L.R + V_{d3}$$

Or,
$$V_{ref} = (L.\eta \ln K) V_T + V_{d3} = (L.\eta \ln K) V_T + \eta V_T \ln \frac{1}{K I_n}$$

The TC of the bandgap reference is zero when,

$$\frac{\partial V_{rel}}{\partial T} = L \eta \ln K \frac{\partial V_T}{\partial T} + \frac{\partial V_{d3}}{\partial T} = 0$$

$$\frac{\partial V_{ref}}{\partial T} = L.\eta \ln K \underbrace{\frac{\partial V_T}{\partial T}}_{0.085 \text{mV/°C}} + \underbrace{\frac{\partial V_{r3}}{\partial T}}_{-2 \text{mV/°C}} = 0$$

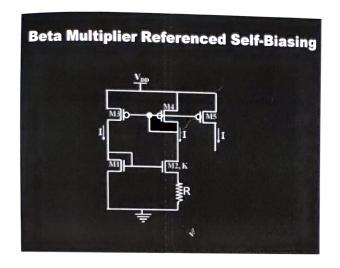
This is true when,

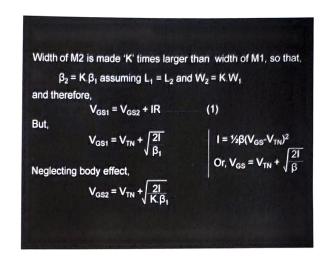
$$L.\eta \ln K = 2/0.085 = 23.5$$

For η=1 and K=8 the factor L = 11.3 ≈ 12 for a zero TC.

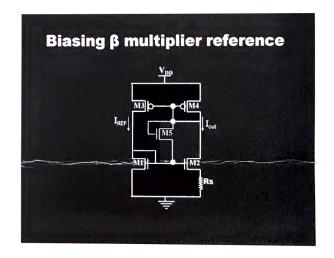
The value of V_{ref} [for η =1,K=8, L=12, V_T =26mV, l=10 μA_s I_S =10 $^{15}A_s$ T=300°K] will be,

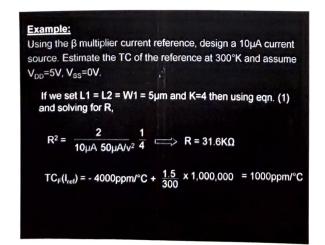
$$V_{ref} = (L.\eta \ln K) V_T + \eta V_T \ln \frac{1}{K l_s} = 1.25V$$

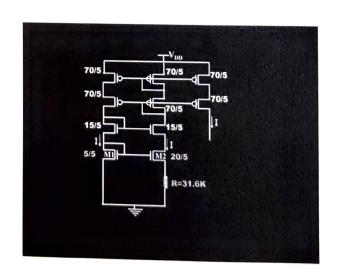




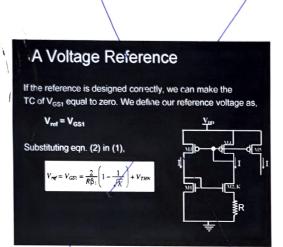
Solving for I,
$$I = \frac{2}{R^2\beta_1} \left[1 - \sqrt{\frac{1}{K}} \right]^2 \qquad (2)$$
 This is the basic design equation for this reference. K is always greater than 1. Temperature coeff. of the current reference is,
$$TC_F(I_{rel}) = \frac{1}{I} \frac{\partial I}{\partial I} = -2 \frac{1}{R} \frac{\partial R}{\partial T} - \frac{1}{\beta I} \frac{\partial \beta_1}{\partial T} = -4000 \text{ppm} I^{\circ} C + \frac{1.5}{T}$$



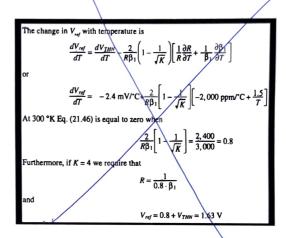




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- There will be an error in the reference voltage associated with the change in the threshold voltage due to process variations and body effect as well as changes in R, β , and T.
- Using p-channel MOSFETs in their own well eliminates errors due to the body effect.
- The threshold voltage can vary by as much as 20 percent (this is part of the reason why the body effect is neglected so often in our hand calculations).
- Thus, precision voltages are more difficult to achieve than the bandgap reference of the last section. Often, voltage references are adjusted on die by laser trimming via metal options a resistor value.



The following example illustrates the design and temperature performance of a zero \emph{TC} voltage reference using the β multiplier self-biased reference.

Design a zero TC voltage β multiplier reference at 300°K with $V_{ss}=0$ V and $V_{DD}=5$ V. Simulate the design for changing V_{DD} and temperature.

 We will use the general cascode schematic shown earlier with V_{DD} swept in the simulations and V_{SS} =O.

The resistor for this design is,

$$R = \frac{1}{0.8 \, \beta_1} = \frac{1}{0.8 \times 50} = 25 \, K\Omega$$